Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
Ll	102218	(powder filler metal) near3 (insulating insulated insulate insulation)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L2	298568	(powder filler metal) near3 (coating coated coat)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L3	146593	(powder filler metal) near3 (treat treating treated treatment)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L4	507458	L1 L2 L3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L5	42242	(dielectric near2 constant) with ("15" "16" "17" "18" "19" "20" "21" "22" "23" "24" "25" "26" "27" "28" "29" "30" "31" "32" "33" "34" "35" "36" "37" "38" "39" "40" "41" "42" "43" "44" "45" "46" "47" "48" "49" "50" "51" "52" "53" "54" "55" "56" "57" "58" "59" "60" "61" "62" "63" "64" "65" "66" "67" "68" "69" "70" "71" "72" "73" "74" "75" "76" "77" "78" "79" "80" "81" "82" "83" "84" "85" "86" "87" "88" "89" "90" "91" "92" "93" "94" "95" "96" "97" "98" "99" "100")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L6	4285036	resin matrix polymer thermoset thermosetting thermoplastic thermoplast	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L7	3767	L4 and L5 and L6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L8	256602	L4.ti. L4.ab. L4.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L9	804	L7 and L8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L10	125707	(dielectric near2 constant)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57

Lll	54754	L10.ab. L10.ti. L10.clm.	US-PGPUB;	OR	ON	2006/09/15 15:57
Lii	34734	Elo.ao. Elo.ciii.	USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OK .		2000/09/13 13:37
L12	407	L9 and L11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L13	8438	loss adj2 tangent	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
L14	38	L12 and L13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:14
L15	125707	dielectric near2 constant	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:15
L16	1592	satsu-yuichi.in. satsu-yuichi-\$.in. takahashi-akio.in. takahashi-akio-\$.in. fujieda-tadashi.in. fujieda-tadashi-\$.in. ueno-takumi.in. ueno-takumi-\$.in "akahoshi-haruo.in.akahoshi-haruo-"\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:15
L17	100	L15 and L16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:15
L18	38	L17 and (resin thermoset thermosetting thermoplastic) and (powder filler)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:15
L19	1901	(loss near2 tangent) near2 low	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:16
L20	4599	428/409.ccls. 428/413.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:16
L21	11	L19 and L20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:17

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S1	1937	resin.ab. and dielectric.ab. and powder.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:30
S2	672	resin.ab. and dielectric.ab. and powder.ab. and (metal conductive).ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:30
S3	8086	loss near2 tangent	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:29
S4	19	S2 and S3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:36
S5	75	S1 and S3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:31
S6	111561	dielectric near2 constant	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:46
S7	53	S1 and S3 and S6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:36
S8	17	S1 and S3 and S6 and metal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:36
S9	30821	(dielectric near2 constant) near2 high	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:40
S10	. 964 	S9 and S3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:40
S11	19311	resin with metal with powder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:40

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S12	13	S10 and S11		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:46
S13	28483	(metal with powder) same (resin thermoset thermosetting)		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:30
S14	91	S6 and S3 and S13		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:46
S15	1681	(loss near2 tangent) near2 low		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:29
S16	422	S9 and S15		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:30
S17	155	S16 and (resin thermoset thermosetting)		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:23
S18	248051	"mhz" "ghz"		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:34
S19	89	S17 and S18		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:34
S20	528180	particle adj2 (size diameter)		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:34
S21	41	S19 and S20		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:39
S22	639	S3 with S18		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 13:40

S23	55	S17 and S22		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 14:30
S24	11	S17 and agglomerate		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 14:30
S25	10520	S9 and (resin thermoset thermosetting polymer thermoplastic)		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 14:33
S26	304	S25 and agglomerate		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 14:33
S27	6910	S9 and (resin thermoset thermosetting thermoplastic)		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 14:33
S28	219	S27 and agglomerate		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:21
S29	36942	(ceramic filler) near5 (coated plated electroplated)		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:22
S30	302	S27 and S29		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:22
S31	160	S16 and (resin thermoset thermosetting thermoplastic)		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:55
S32	11	S31 and S29		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:52
S33	5	S31 not S17	-	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:24

S34	1594	satsu-yuichi.in. satsu-yuichi-\$.in. takahashi-akio.in. takahashi-akio-\$.in. fujieda-tadashi.in. fujieda-tadashi-\$.in. ueno-takumi.in. ueno-takumi-\$.in. "akahoshi-haruo.in.akahoshi-haruo-"\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:54
S35	105	S6 and S34	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:54
S36	91	S35 and (resin thermoset thermosetting thermoplastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:55
S37	25	S35 and (resin thermoset thermosetting thermoplastic) and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:57
S38	8	S35 and (resin thermoset thermosetting thermoplastic) and S9 and S20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 15:57
S39	39	S35 and (resin thermoset thermosetting thermoplastic) and (powder filler)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:15
S40	13190	S6.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 16:01
S41	11	S34 and S40	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 16:02
S42	5	S34 and S40 and (metal powder ceramic filler).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 16:05
S43	4451	428/409.ccls. 428/413.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 16:06
S44	9	S15 and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 16:16

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S45	10	"6068782".pn. jp-03254011-\$.did. ep-1150311-\$.did. ep-537371-\$.did. jp-06172618-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 16:26
S46	117775	dielectric near2 constant	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:53
S47	264077	"mhz" "ghz"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:46
S48	6788	S46 same S47	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:46
S49	3900185	resin binder polymer thermoset thermosetting thermoplast thermoplastic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:47
S50	212863	(powder filler) with (coating coated coat insulating insulated unsulate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:14
S51	510	S48 and S49 and S50	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:49
S52	202670	(metal metallic) with powder	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:49
S53	153	S51 and S52	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 12:49
S54	39642	(dielectric near2 constant) with ("15" "16" "17" "18" "19" "20" "21" "22" "23" "24" "25" "26" "27" "28" "29" "30" "31" "32" "33" "34" "35" "36" "37" "38" "39" "40" "41" "42" "43" "44" "45" "46" "47" "48" "49" "50" "51" "52" "53" "54" "55" "56" "57" "58" "59" "60" "61" "62" "63" "64" "65" "66" "67" "68" "69" "70" "71" "72" "73" "74" "75" "76" "77" "78" "79" "80" "81" "82" "83" "84" "85" "86" "87" "88" "89" "90" "91" "92" "93" "94" "95" "96" "97" "98" "99" "100")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:05
S55	214210	(powder filler) with (coating coated coat insulating insulated insulate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:03

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S56	293	S48 and S54 and S49 and S55	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:10
S57	100	S48 and S54 and S49 and S55 and S52	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:10
S58	474194	(powder filler metal) near5 (coating coated coat insulating insulated insulate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:25
S59	587	S48 and S54 and S49 and S58	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:15
S60	112	S48 and S54 and S49 and S58 and S52	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:16
S61	97977	(powder filler metal) near3 (insulating insulated insulate insulation)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:23
S62	36135	S61.ti. S61.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:23
S63	30	S62 and S48 and S54	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:26
S64	287991	(powder filler metal) near3 (coating coated coat)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:29
S65	130448	S64.ab. S64.ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:26
S66	21	S65 and S48 and S54	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:30

S67	142319	(powder filler metal) near3 (treat treating treated treatment)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:30
S68	59785	S67.ab. S67.ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:30
S69	5	S68 and S48 and S54	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/02/17 13:30
S70	98153	(powder filler metal) near3 (insulating insulated insulate insulation)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:05
S71	288499	(powder filler metal) near3 (coating coated coat)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:05
S72	142525	(powder filler metal) near3 (treat treating treated treatment)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:05
S73	490870	S70 S71 S72	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:05
S74	39760	(dielectric near2 constant) with ("15" "16" "17" "18" "19" "20" "21" "22" "23" "24" "25" "26" "27" "28" "29" "30" "31" "32" "33" "34" "35" "36" "37" "38" "39" "40" "41" "42" "43" "44" "45" "46" "47" "48" "49" "50" "51" "52" "53" "54" "55" "56" "57" "58" "59" "60" "61" "62" "63" "64" "65" "66" "67" "68" "69" "70" "71" "72" "73" "74" "75" "76" "77" "78" "79" "80" "81" "82" "83" "84" "85" "86" "87" "88" "89" "90" "91" "92" "93" "94" "95" "96" "97" "98" "99" "100")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:10
S75	4128836	resin matrix polymer thermoset thermosetting thermoplastic thermoplast	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:08
S76	3506	S73 and S74 and S75	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:10
S77	250414	S73.ti. S73.ab. S73.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:10

S78	757	S76 and S77	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:10
S79	118147	(dielectric near2 constant)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:21
S80	52145	S79.ab. S79.ti. S79.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:11
S81	384	S78 and S80	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:15
S82	7975	loss adj2 tangent	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:15
S83	35	S81 and S82	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/09/15 15:57
S84	32636	high near2 (dielectric near2 constant)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:21
S85	11986	S84.ti. S84.ab. S84.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:21
S86	36	S85 and S73 and S74 and S75 and S82	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 15:51
S87	280	(S74.ab. S74.ti. S85.ab. S85.ti. S85.clm.) and S74 and S75 and S73	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 16:20
S88	42	S87 and S82	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 16:20

S89	20658	S73 with salt	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 16:20
S90	8	(S74.ab. S74.ti. S85.ab. S85.ti. S85.clm.) and S74 and S75 and S89	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 16:36
S91	5	(S74.ab. S74.ti. S85.ab. S85.ti. S85.clm.) and S74 and S75 and S89 and ("khz" "mhz")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 16:52
S92	3	(S74.ab. S74.ti. S85.ab. S85.ti. S85.clm.) and S74 and S75 and S89 and ("khz" "mhz") and S82	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 16:56
S93	10		US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 16:54
S94	4	(S74.ab. S74.ti. S85.ab. S85.ti. S85.clm.) and S74 and S75 and S89 and ("khz" "mhz") and agglomerat\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 17:32
S95	4	(S74.ab. S74.ti. S85.ab. S85.ti. S85.clm.) and S74 and S75 and S89 and ("khz" "mhz") and (plated plating electroplated electroplating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2006/03/01 17:33

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